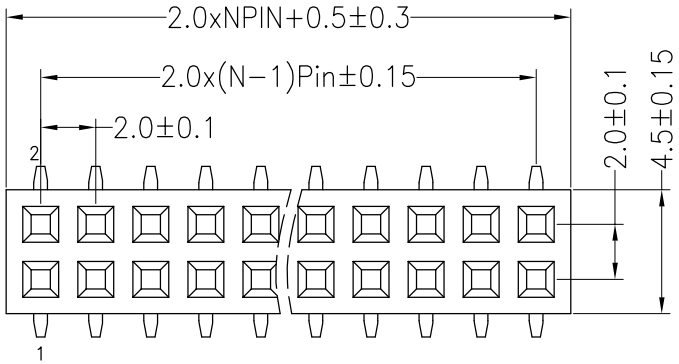
HSF RoHS

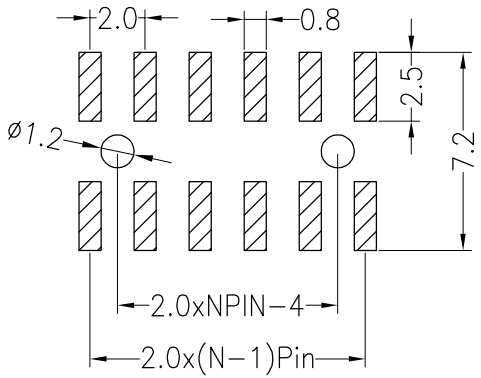
FILE NO :E362810

SPECIFICATIONS
Rated Current:1.5AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



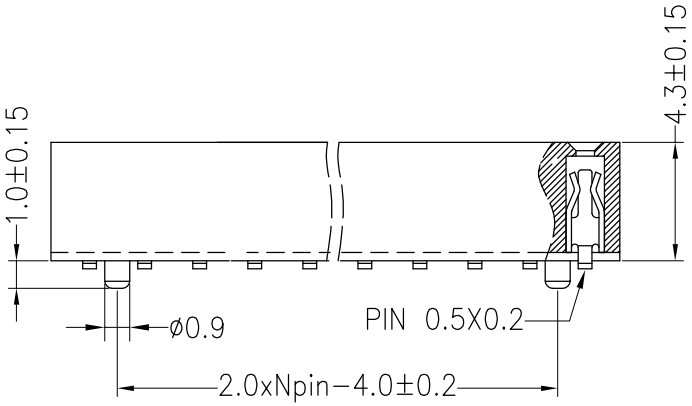

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

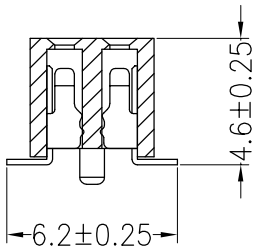



## *Ordering Information*

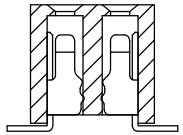
2343 02 XX X X XX M U X 0X

| | | | | |
|---|---|---|---|---|
| No.of Pins Per Row 2~40 | Insulator Material Option<br>C=BK−PA6T<br>E=BK−PA9T<br>F=BK−LCP | Post<br>W=With Post<br>N=W/O Post | Contact Plating<br>G1:Gold Flash<br>G2:1.5U" Gold<br>G3:2U" Gold<br>G4:3U" Gold<br>G5:5U" Gold<br>G6:10U" Gold<br>G7:15U" Gold<br>S0:Gold Flash/Tin<br>SN:Tin | Packing<br>0=PE Bag<br>A=Tray<br>T=Tube<br>P=Tube+Cap<br>R=Reel+Cap |




W= With Post



N= W/O Post

| REV | DATE | MODIFICATION DESCRIPTION | CHANGE |
|---|---|---|---|
| A0 | 2012.07.23 | NEW DRAWING | |

| OPERATION | | DRAW | Liu Miao | 12.07.23 | SCALE | FIT |
|---|---|---|---|---|---|---|
| X.X | ±0.30 | | | | UNIT | mm |
| X.XX | ±0.20 | CHECK | | | SIZE | A4 |
| X.XXX | ±0.10 | | | | SHEET | 1/1 |
| Angle | ±3° | APPROVE | | | PROJ. | |
| DIM | TOL | | | | | |

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

| PART NO. | 234302XXXXXXMUX0X |
|---|---|
| TITLE: | 2.00PF H4.3mm 2xNpin SMT W4.50 |